



## **Optoscribe Secures Multi-Million Pound Deal**

**LIVINGSTON, UK – 28 February, 2018** – Optoscribe a global supplier of glass-based integrated photonic components is delighted to announce a multi-million pound procurement agreement to supply transceiver optical interconnect chips, in volume, to a global Tier 1 optical networking supplier for its photonic integration projects that address the fast growing datacenter interconnect (DCI) market.

Optoscribe will deliver a range of photonic components integrated into a single monolithic glass chip allowing the customer to quickly ramp its product to volume manufacturing.

Nick Psaila, Chief Executive Officer of Optoscribe said: “This agreement is great news for the company and further endorses our unique 3D glass waveguide interface technology that enables simple coupling of fiber to active elements such as arrays of lasers and photodiodes in optical transceivers.

“This contract underpins our commitment to component manufacturing for the datacenter market and, we are well placed to grow rapidly in line with demand.”

Steve McMahon, Chief Commercial Officer of Optoscribe commented: “The Company has provided a good technical solution that is cost-effective and improves performance and we are very excited to be a key supplier partner to our customer, who is at the forefront of providing optical solutions that advance next-generation networks for content delivery in the fast growing hyperscale datacenter market.”

Optoscribe will be at OFC 2018 booth #6230.

### **About Optoscribe Limited**

Formed in 2010, Optoscribe uses its innovative laser direct write technology to manufacture glass-based integrated photonic components for the telecommunications and data communications markets. These monolithic optical products are primarily used by high volume optical transceiver manufacturers. The transceivers provide the optical communication network that is used in datacenters.

The company is located in Livingston, UK